Description

The HXT14100 is a single channel, low power, Linear PAM4 VCSEL driver for SR optical applications that supports signaling rates up to 28GBaud or 56Gbps PAM4. In conjunction with an individual DFB laser diode, the device handles the complete digital-to-optical conversion, including CML input with equalization, laser driver, drive control and supervision.

The HXT14100 also integrates a number of functions required for Automatic Power Control (APC), as well as internal and module temperature measurements and reporting. Using the included RSSI input, the module receive optical power can also be measured and reported.

Designed for direct DC-coupled die in TOSA applications with a small number of additional components for cost-effective and compact assemblies. Available in die form.

Typical Applications

- SFP56 Ethernet modules for datacenter applications
- 50G Ethernet SR AOC
- Fiber Channel modules
- Infiniband EDR optical modules

Features

- 230mW per channel Power Dissipation typical
- Supports up to: I_{MOD} = 12mA & I_{BIAS} = 12mA with V_{CC} = 3.3V
- Integrated 12-bit ADC with 6 channel analog multiplexor front-end
- Programmable 8-bit Laser Modulation and Bias current control
- Integrated Bias Monitor, Transmit and Receive Power monitor capability
- Automatic Power Control (APC)
- Programmable Input LOS and Squelch function with disable, Transmit Disable, and Transmit Fault indication
- Programmable Input CTLE Equalization
- Integrated Temperature Sensor and input for external module temperature sensor
- Interrupts with User selectable Mask control
- Input Polarity Inversion
- Laser Disable for I_{MOD} and I_{BIAS}
- Integrated OTP for calibration
- 2-wire interface control

Ordering Information

<table>
<thead>
<tr>
<th>Part</th>
<th>Temp Range</th>
<th>Dimensions</th>
</tr>
</thead>
<tbody>
<tr>
<td>HXT14100-DNU(^1)</td>
<td>-5°C to +95°C</td>
<td>Bare Die: 1350 x 1120μm</td>
</tr>
<tr>
<td>HXT14100-TNU(^2)</td>
<td></td>
<td></td>
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<tr>
<td>HXT14100-EVB</td>
<td>Room Temp</td>
<td>Evaluation Board</td>
</tr>
</tbody>
</table>

Notes: Product Shipping Carrier Type: \(^1\) – Waffle Pack; \(^2\) – Blue Tape

For price, delivery schedules, and to place orders, please contact IDT: [www.IDT.com/go/sales](http://www.IDT.com/go/sales)
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